



# Tandem Boost Schottky Diode - 8Amp 600Volt

### Features

- -600Volt Tandem Schottky Barrier Diode
- -Low TRR, QRR and IRRM
- -Low VF and IR
- -Low Switching and Conduction Losses
- -Higher Efficiency
- -High Junction Temperature Capability
- -Plastic package has Underwriters Laboratory Flammability Classifications 94V-0
- -Halogen-Free

## Application

- -Power Factor Correction(PFC), especially on Discontinuous Current Mode(DCM)
- -AC/DC Converters
- -DC/AC Inverters

# ■ Maximum ratings and Electrical characteristics

Parameters		Symbol	Ratings		Unit
Repetitive Peak Reverse Voltage		VRRM	600		V
Average Forward Current		lF(AV)	8		А
Non-repetitive Peak Forward Surge Current		IFSM	80		А
Forward Voltage Drop at Average Forward Current	TJ=25°C	VF	2.0		V
	TJ=125°C		1.8		
Reverse Leakage Current at Rated DC Blocking Voltage	TJ=25°C	- IR	10		uA
	TJ=125°C	IK	250		
Typical Junction Capacitance		CJ	200		pF
Reverse Recovery Time  IF=0.5A, IR=1.0A, IRR=0.25A  IF=2A, VR=400V, dI/dt=200A/us		Trr	TYP.	MAX.	ns
			16	20	
			38	45	
Reverse Recovery Charge		Qrr	95		nC
IF=2A, VR=400V, dI/dt=200A/us					
Maximum Reverse Recovery Current  IF=2A, VR=400V, dI/dt=200A/us		IRRM	5		А
Softness Factor		S	0.75		
IF=2A, VR=400V, dI/dt=200A/us					
Typical Thermal Resistance		RøJC	4.5		°C/W
Operating and Storage Temperature Range		TJ, TSTG	-50 to +150		°C

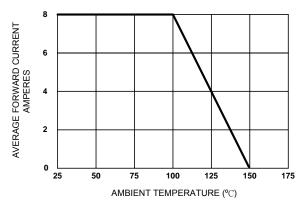


Figure 1. Forward Current Derating Curve

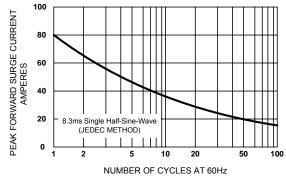


Figure 2. Maximum Non-repetitive Surge Current

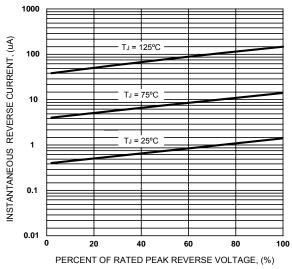


Figure 3. Typical Reverse Characteristics

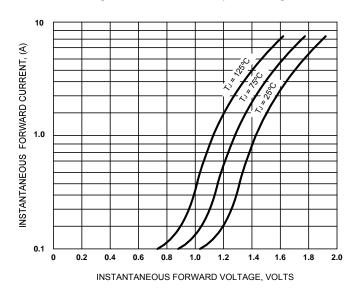


Figure 4. Typical Forward Characteristics

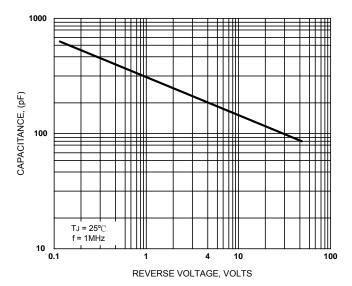


Figure 5. Typical Junction Capacitance

#### TM806FCH ITO-220AC <u>C</u> 0 D 0 K Ε F 0-G → N **←** Ķ À DIMENSIONS INCHES MILLIMETERS DIM NOTE MIN MAX MIN MAX .598 .638 15.20 16.20 Α В .386 .410 9.80 10.40 С .098 .138 2.50 3.50 D .232 5.90 7.00 .276 Ε .344 .384 8.75 9.75 F .118 .142 3.00 3.60 G 13.50 .472 .532 12.00 Н .093 .112 2.35 2.85 I .026 .037 0.65 0.95 J .012 .026 0.30 0.65 Κ .124 .148 3.15 3.75 L .173 .189 4.40 4.80 М .091 .106 2.30 2.70 Ν .094 .134 3.40 1.00 0 .039 .055 1.40



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